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PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: Larry D. Kinsman

Serial No.: 10/792,229

Filed: March 3, 2004

For: BUMPED DIE AND WIRE BONDED
BOARD-ON-CHIP PACKAGE

Confirmation No.: 4782

Examiner: T. Ho

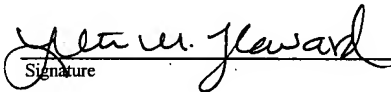
Group Art Unit: 2818

Attorney Docket No.: 2269-4585.3US
(00-0658.03/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail on the date of deposit shown below with sufficient postage and in an envelope addressed to the Mail Stop Amendment, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450.

September 29, 2005
Date


Signature

Leta M. Howard
Name (Type/Print)

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO/SB/08A be considered by the Examiner and made of record. A copy of the U.S. patent is not being submitted pursuant to M.P.E.P. 609 III A(2). The listed document was cited by the Office in co-pending application Serial No. 10/793,564, filed on March 3, 2004, and directed to a related invention.

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as

Serial No. 10/792,229

defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicant herein that no other possible material information as defined in 37 C.F.R. § 1.56 (b) exists.

U.S. Patent Documents

<u>U.S. Patent No.</u>	<u>Publication Date</u>	<u>Patentee</u>
US - 5,598,031	01/1997	Groover et al.

Applicant offers to supply any explanation or discussion of the document which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed after the mailing date of the first Office Action on the merits.

I hereby certify that no item of information contained in the Supplemental Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application or, to the knowledge of the undersigned after making reasonable inquiry, was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of the statement, and therefore no fee is due.

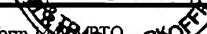
Respectfully submitted,



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Date: September 29, 2005
JRD/djp:lmh

Enclosures: Form PTO/SB/08A

Substitution for form 101, PTO Form 261, 12/01  INFORMATION DISCLOSURE STATEMENT BY APPLICANT <i>(use as many sheets as necessary)</i>				Complete if Known	
				Application Number	10/792,229
				Filing Date	March 3, 2004
				First Named Inventor	Larry D. Kinsman
				Group Art Unit	2818
				Examiner Name	T. Ho
				Attorney Docket Number	2269-4585.3US (00-658.03/US)
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